

## Yipeng Zhang

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### EDUCATION

**School of Engineering and Applied Sciences, University at Buffalo (SUNY)**

B.S. in Chemical Engineering (Cum Laude)

**Fu Foundation School of Engineering and Applied Science, Columbia University**

M.S. in Chemical Engineering

### RESEARCH EXPERIENCE

***Institute of Chemistry Chinese Academy of Sciences, Advisor: Dr. Kun Zheng***

*May 2021 – October 2021*

- Participated in the project aims to improve the Interfacial thermal conductance between filler and polymer matrix using surface treatments.
- Participated in the study of boron nitride nanosheet polymer composite with high out-of-plane thermal conductivity.
- Co-authored an article published in the *Journal of Physics: Conference Series*.

***Chemical Engineering, Columbia University, Advisor: Prof. Sanat K. Kumar***

*September 2022 – Present*

- Synthesized polymer grafted silica particles via atom transfer radical polymerization (ATRP) for gas permeation membranes and polymer-particle composite characteristic studies (DSC, XPCS, TEM).
- Synthesized quaternized poly (styrene-co-vinyl benzyl chloride) for anion exchange membrane.
- Reviewed literature and studied the kinetics of ATRP polymerization.
- Get trained on diverse techniques to characterize polymer and nanoparticle materials, including TGA, GPC, DLS, and SAXS. Analyzed data obtained from these instruments via Python and MATLAB.

### PUBLICATION

Wei Yang, Yun Chen, **Yipeng Zhang**, YongSheng Fu, Kun Zheng, Kun Wang, YongMei Ma, “*Thermal conductance of epoxy/alumina interfaces*”, presented on 2021 International Conference on Advanced Materials and Mechatronics, Kunming·China, publish on *Journal of Physics: Conference Series* (ISSN: 1742-6588)

### STUDENT GROUP EXPERIENCE

***Columbia Chinese Orchestra (CCO), Columbia University***

*May 2023 – Present*

Suona (a traditional Chinese instrument) performer.

### SKILLS

**Laboratory:** Thermogravimetric analyzer (TGA), gel permeation chromatography (GPC), dynamic light scattering (DLS), small angle x-ray scattering (SAXS), UV-Vis, and glovebox.

**Programming and software:** MATLAB, Python, Polymath, UniSim Design, Microsoft Office.